

soft x-ray absorption and resonant scattering at ALBA



BOREAS BL29, Beamline Of REsonant Absortion and Scattering

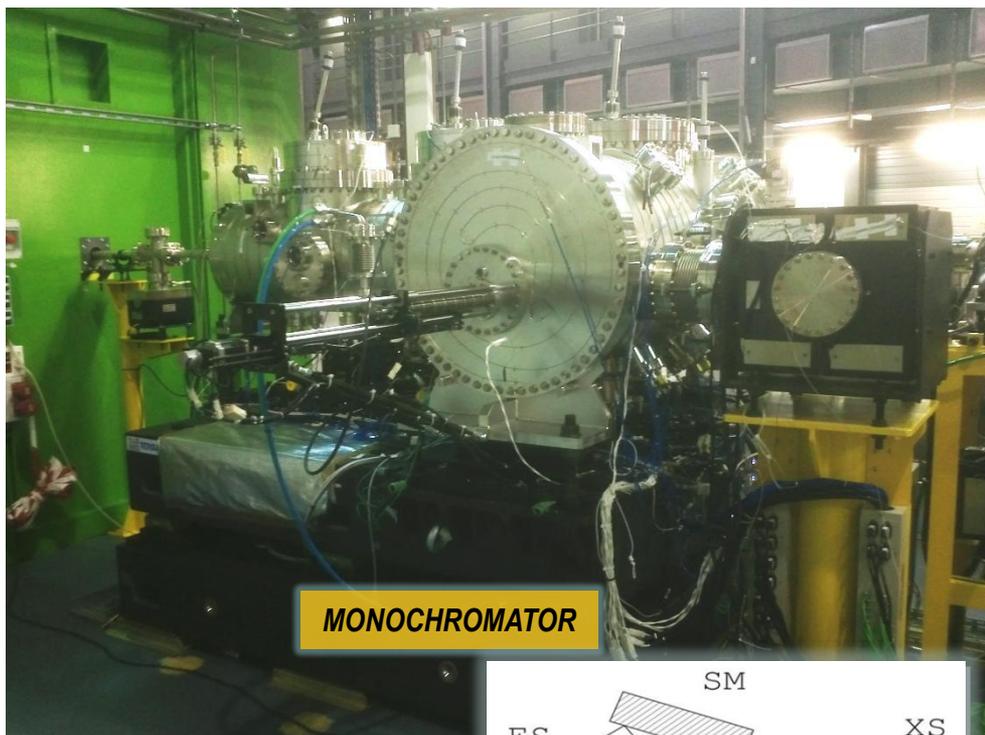
BOREAS, Beamline Of REsonant Absorption and Scattering

Scientific Case

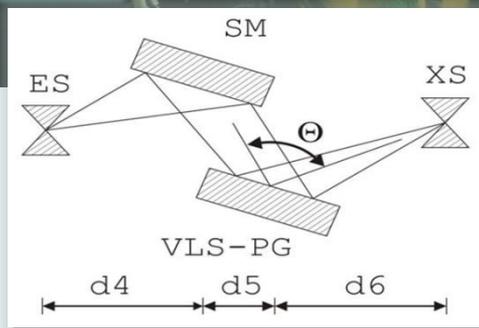
Soft x-rays: 80-4000 eV, Apple II, 3 VLS-grating mono, two endstations for XAS, XMCD/ XMLD, and XRMS

- Beamline performance, status, commissioning
- Hector endstation
- MaReS endstation
- In-house and user results





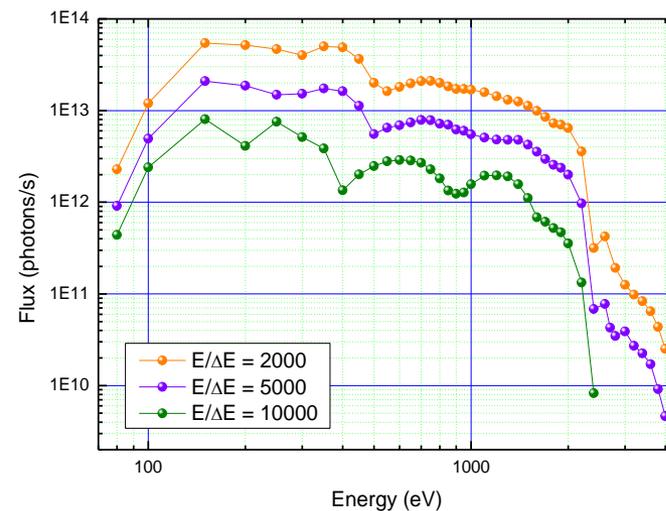
MONOCHROMATOR



GRATING MIRROR COMBINATIONS

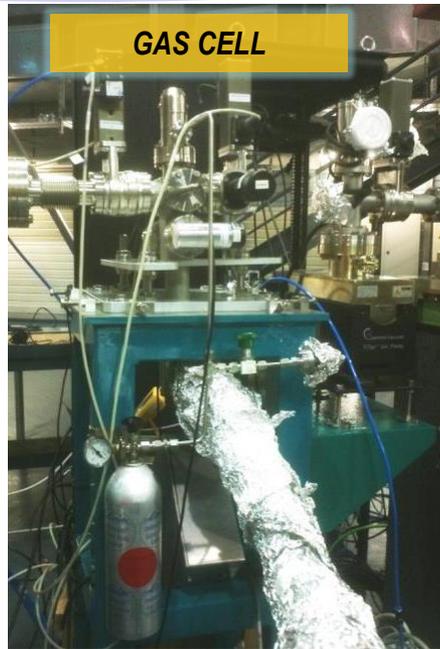
80 – 300 (800) eV	SM1+LEG
250 – 600 (1400) eV	SM2+LEG
380 -1700 eV	SM1+MEG
950 - 3000 eV	SM2+MEG
600 – 2100 eV	SM1+HEG
1900 – 4500 eV	SM2+HEG

Photon flux (calculated)



- **Monochromator chamber :**
3 plane VLS gratings
2 spherical mirrors
(mechanics by Toyama co.)

LEG: 200 l/mm, laminar, Ni coated [35nm]+Cr binding layer
MEG: 800 l/mm, blazed (mech. Ruled + ion beam etch), Rh [35nm]
HEG: 1200l/mm, blazed, Au [35nm]



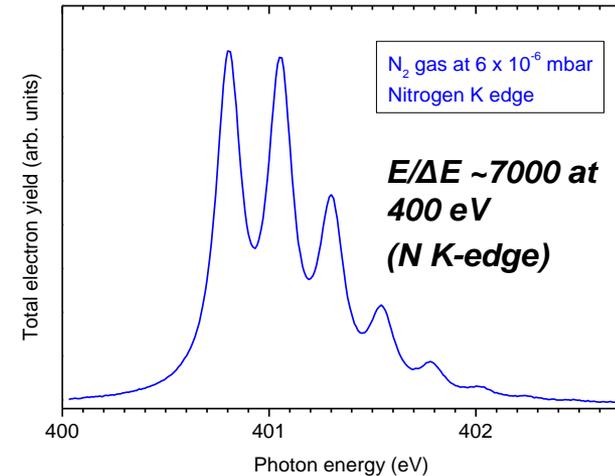
**I zero: AXUV100
(IRD) absolute diode,
QE=hv[eV]/3.65**

photon flux

hν	I _{SR}	Diode current	flux
500eV	70μA	17.3 μA	7.8x10 ¹¹ photons/s ^(*)

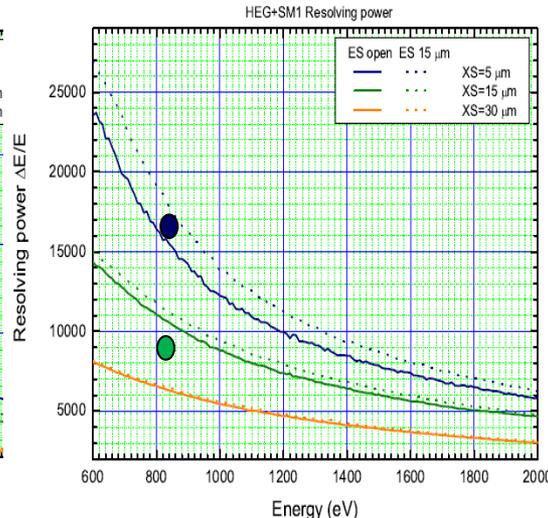
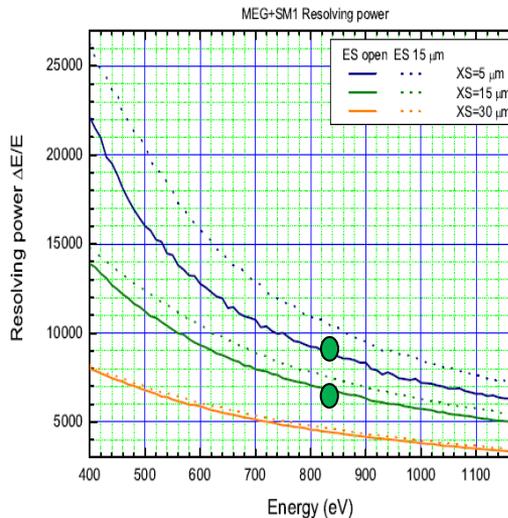
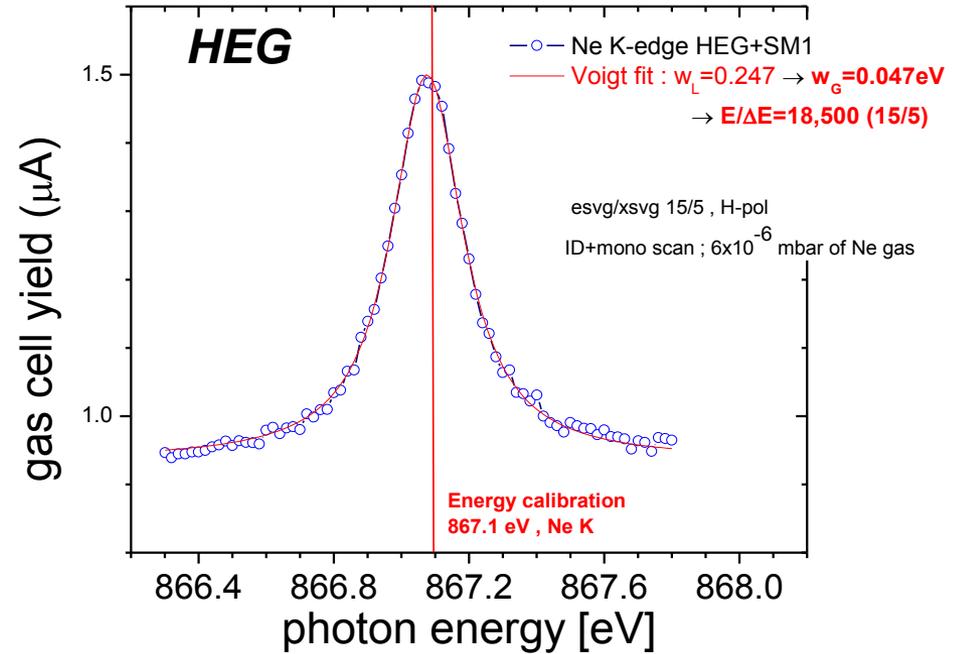
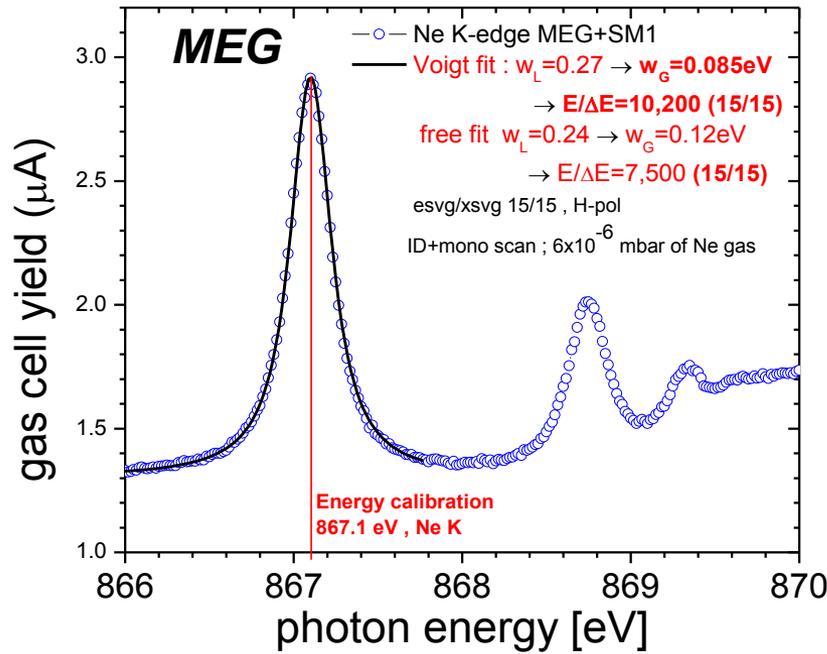
(*) : Circular polarization, ES=15μm; XS=5μm;
Extrapolates to 4-5x10¹² photons/s at I_{SR}=400μA

Resolving power (ES=15/XS=15)

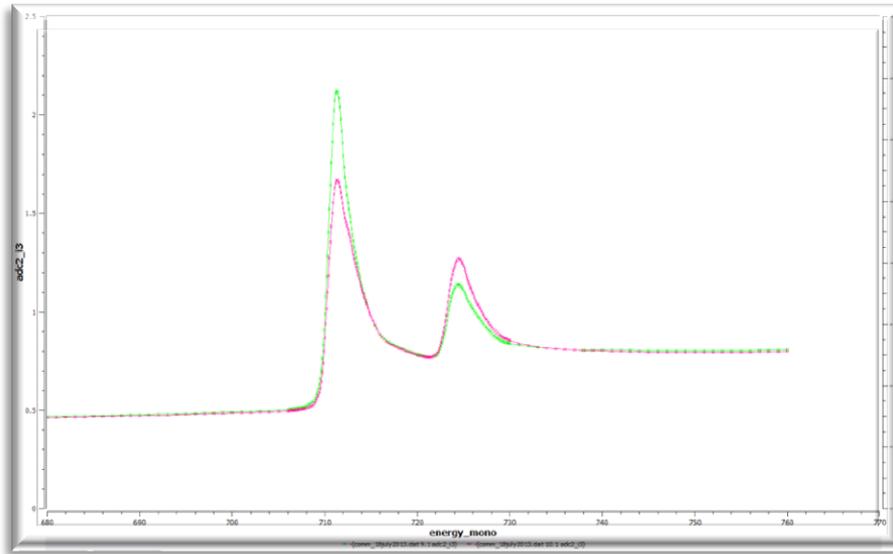


Beam size (micron)

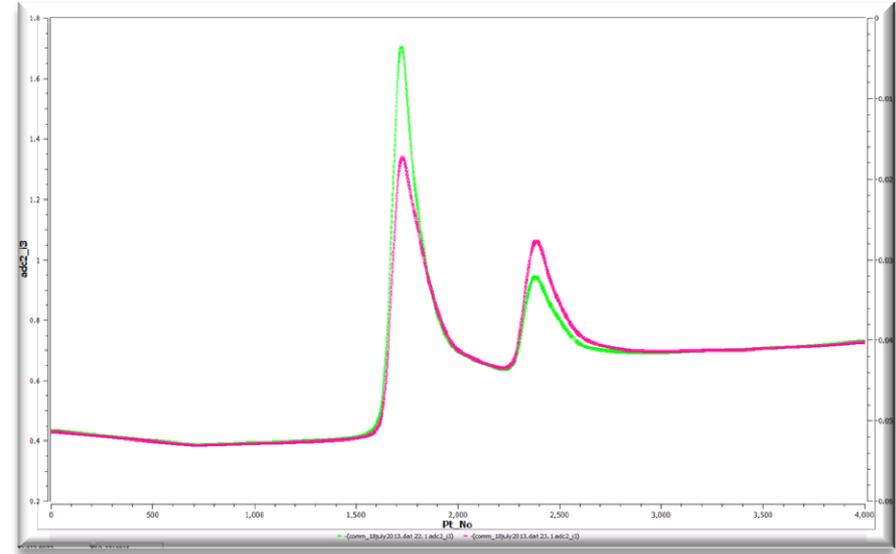
Element	Vertical	Horizontal
exit slit	10	250
ES1	600	250



- At 15/5 slits, MEG and HEG single Lorentzian width is 0.26(8) and 0.25(4) eV
- Width smaller literature Ne K natural width, 0.27±0.02 eV [Floreno et al, RSI]
- Instrumental resolution ~10,000 for 15/15 μm slits and ~20,000 for 15/5 μm,
- Confirmed resolution performance of conceptual design



Step scan, variable step:
Finest res. 0.050 meV
Total time: 17min 30sec
Normalized

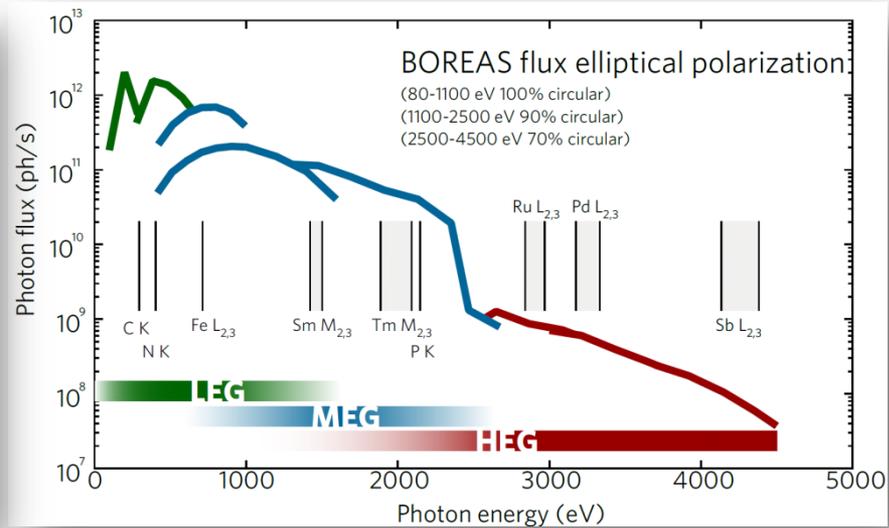
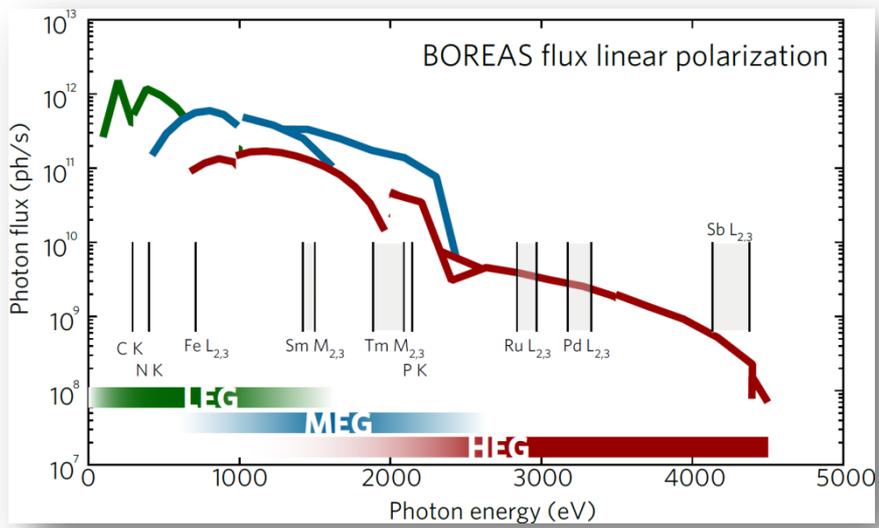


Continuous scans
0.050meV resolution everywhere
Total time : 2min
Not normalized

- Continuous scans can more efficiently use acquisition, benefiting of high frequency sampling
- As important as time saving, is quality of successive measurements.



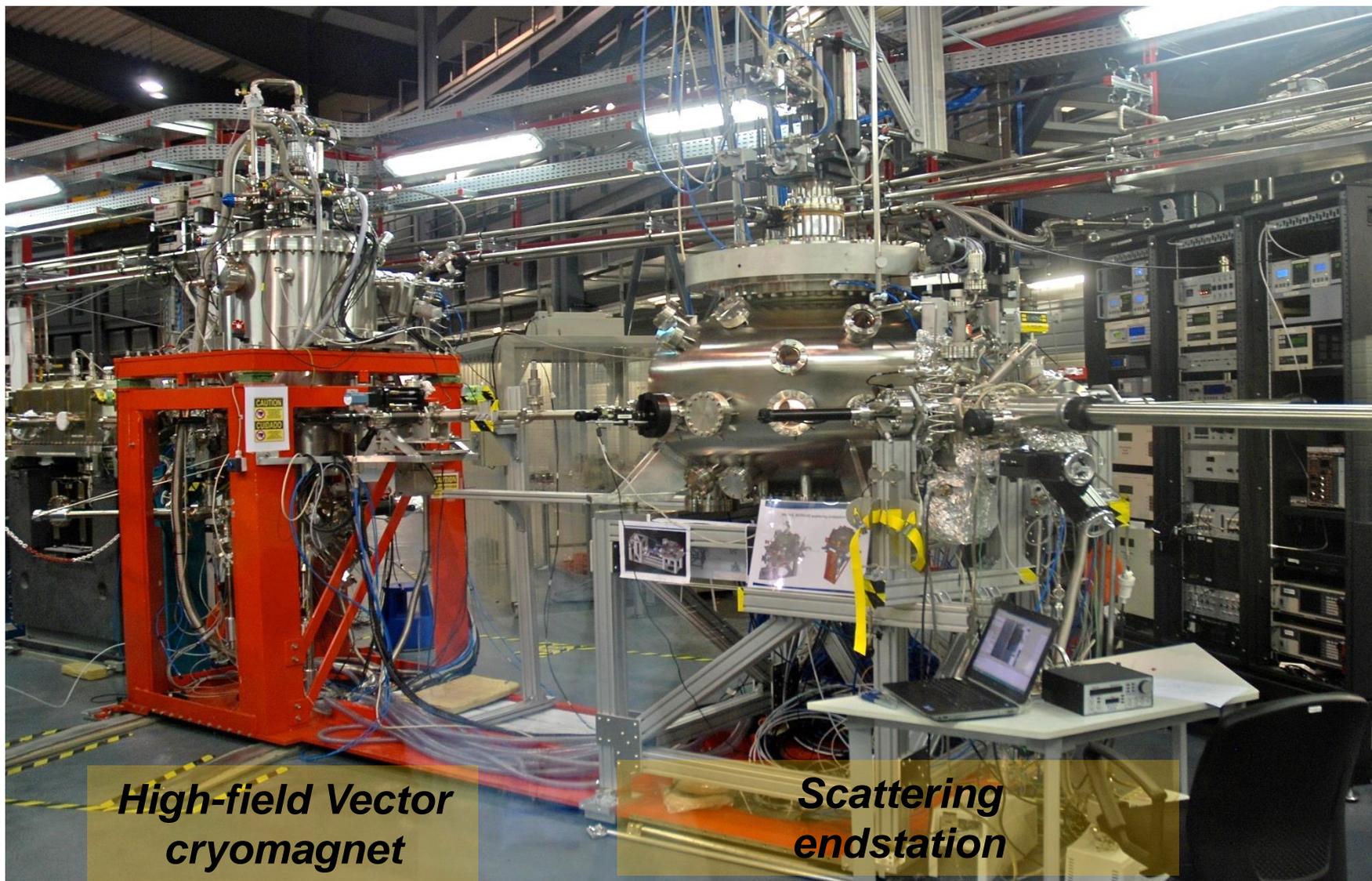
Figure 2. This picture shows the first Insertion Device installed in the ALBA Storage Ring. It is an APPLE-II Undulator, with a period of 71 mm which will give light to BL29-BOREAS.



Linear polarization

Circular & elliptical polarization

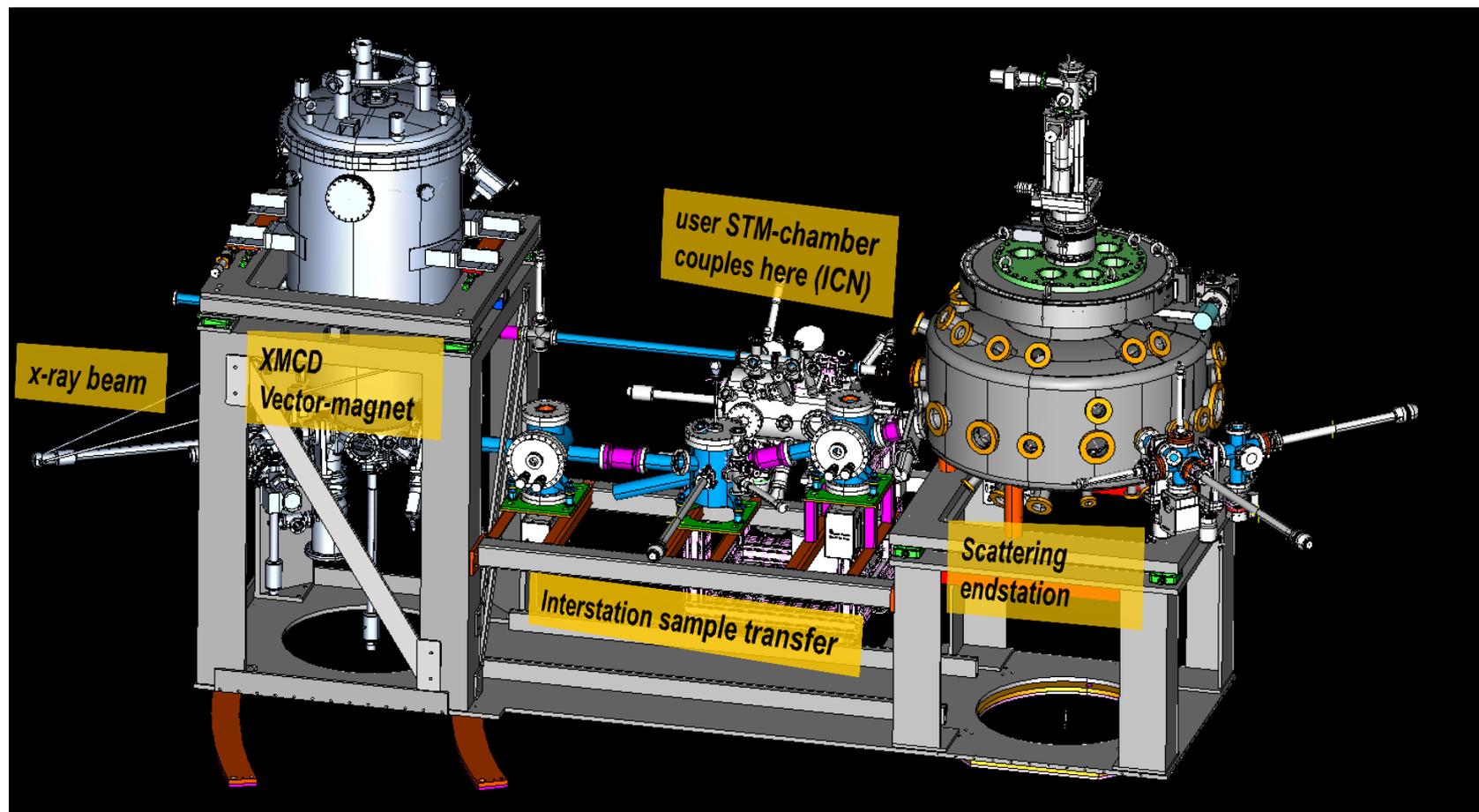
- **Considerably high flux with good resolution in the high energy range (>1.5 keV)**
Typically 1st ID harmonic 100-1100 eV ; 3rdh : 1000-2500 eV approx. ; 3rd, 5th, ... for E>2000 eV
- **Spectral purity:** ID harmonics x grating orders coincidences can be relatively intense



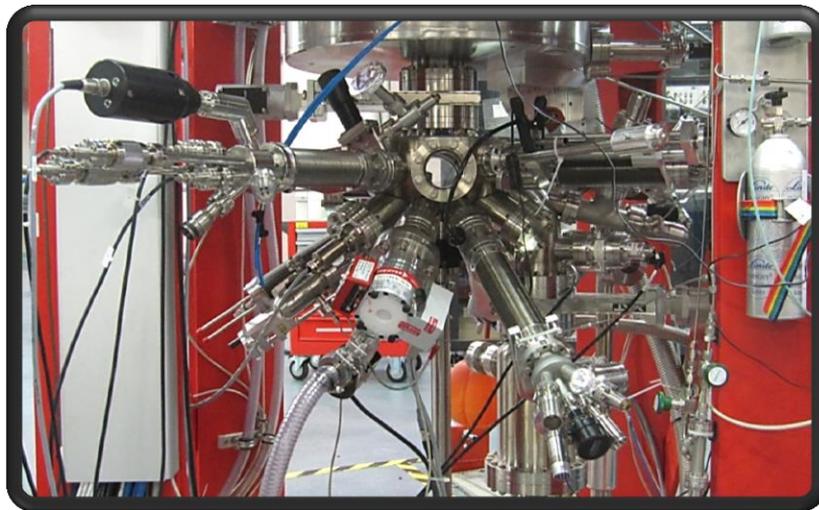
**High-field Vector
cryomagnet**

**Scattering
endstation**

Interstation transfer line & STM– status



- Most elements delivered, chambers bought, support on design approval
- System linking STM and vector magnet is expected to be ready summer 2014



**Vector magnet:
6T, 2T (3D)
Temp.: 2K – 350K
sample contacts**

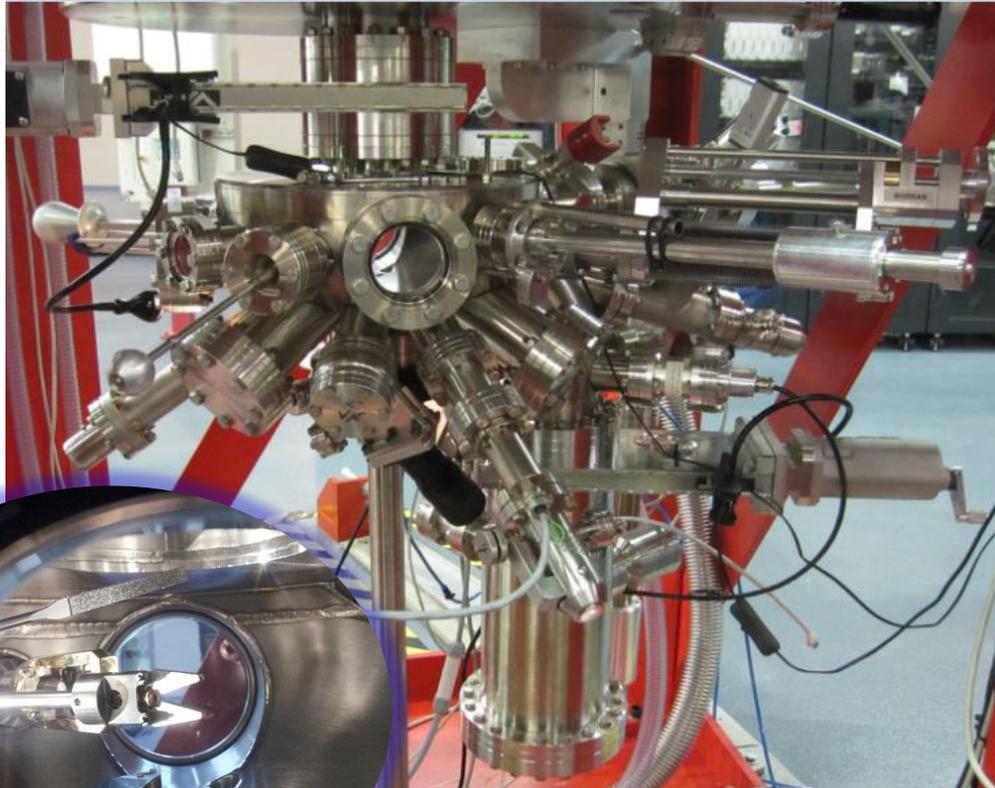


- Temperature control macros ; 3D mode integration (new gui)
- Transmission diode arm (motorized)
- Quadruple metal evaporator, organic evaporator, heating stage, ion gun
- Turbo, LEED/AES prep-ch upgrades (warranting good surface science)
- Fluorescence diode: diode + 2 HV grids for e⁻ repulsion (foil option)
- Many more types of sample holders, clips;
- In progress: bias, HV batteries, ...enhancing TEY detection



Fluorescence diode assembly designed and built at ALBA (installed end Feb'2013)

- **Installed equipment: heating stage, metal evaporator, wobble stick, gas lines, leak valve, quartz balance**



***In-situ cleaver, wobble stick
scraper (file), ash tray***

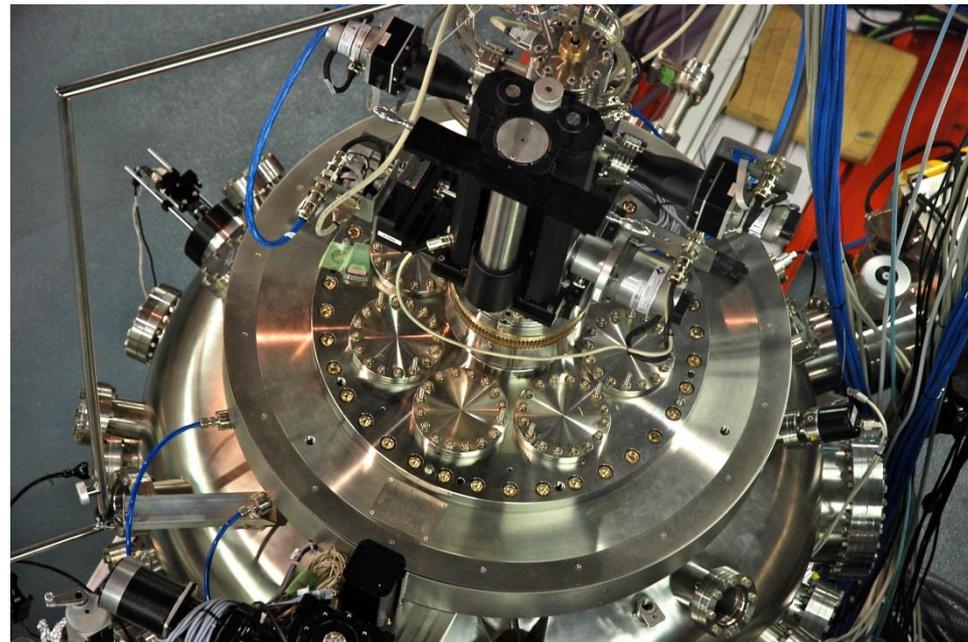
Transmission arm



e-beam heating stage

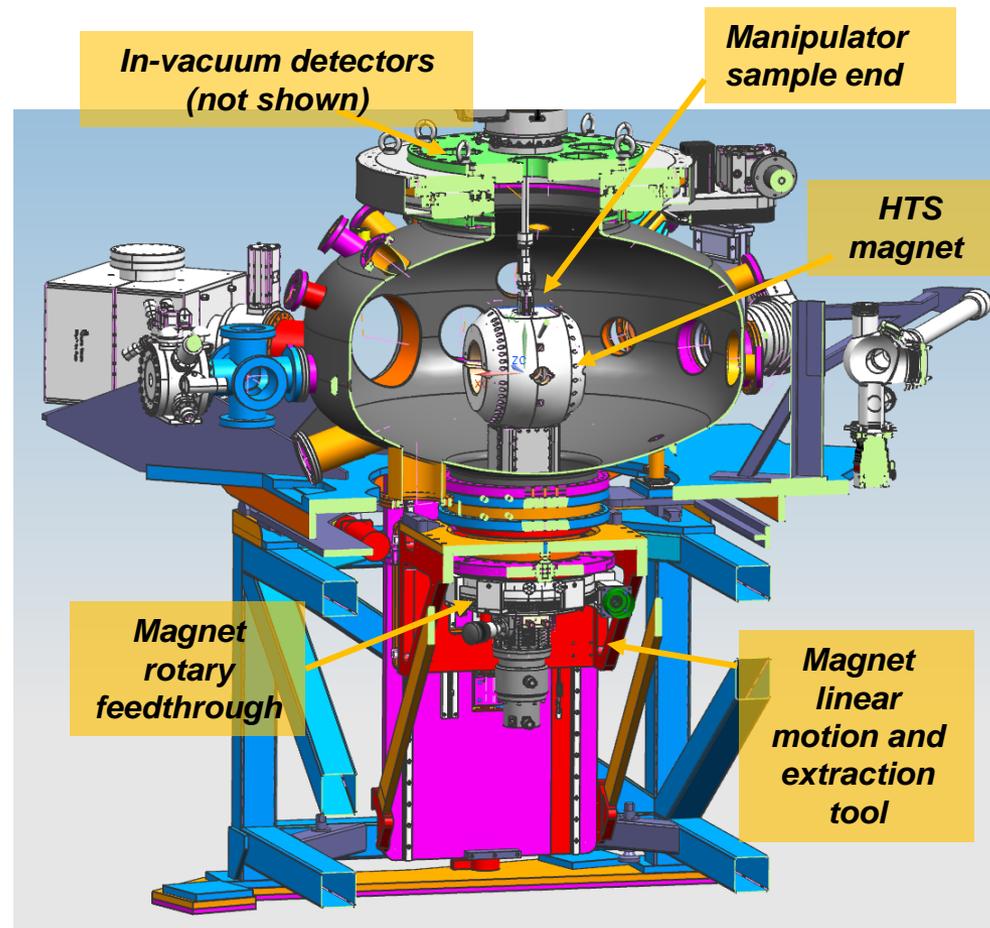
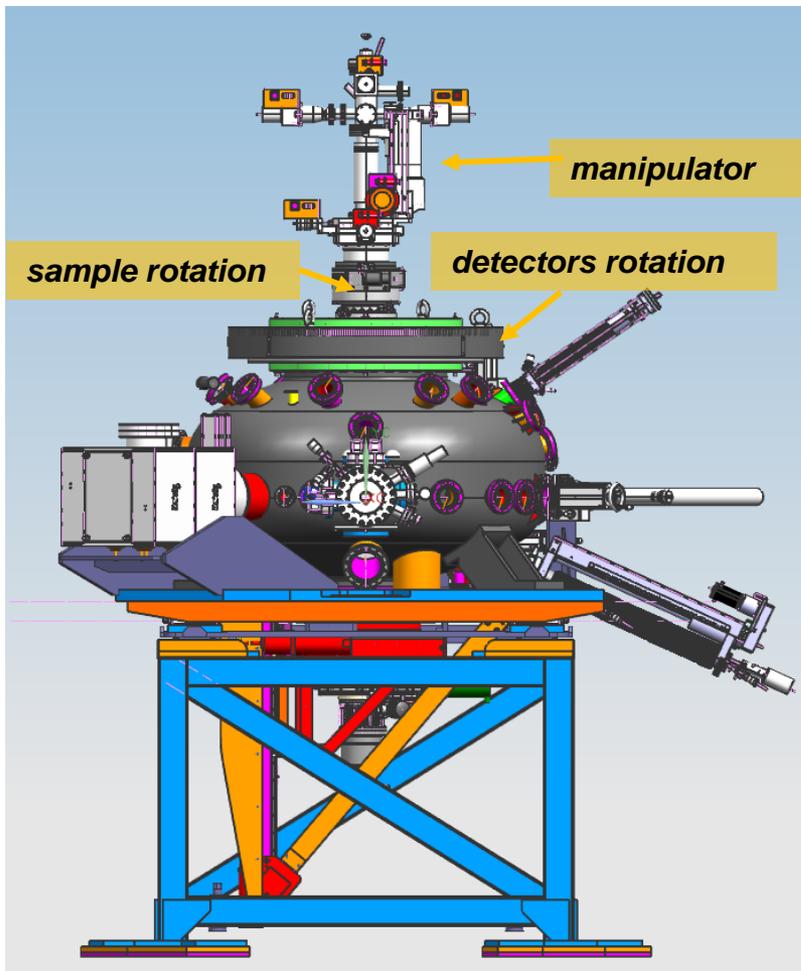


Demanding surface science user&in-house experiments put strong needs for surface science equipment: turbo pump in preparation chamber, multi-sample loading upgrade for load-lock, LEED, evaporation screen, enhanced fluorescence detection



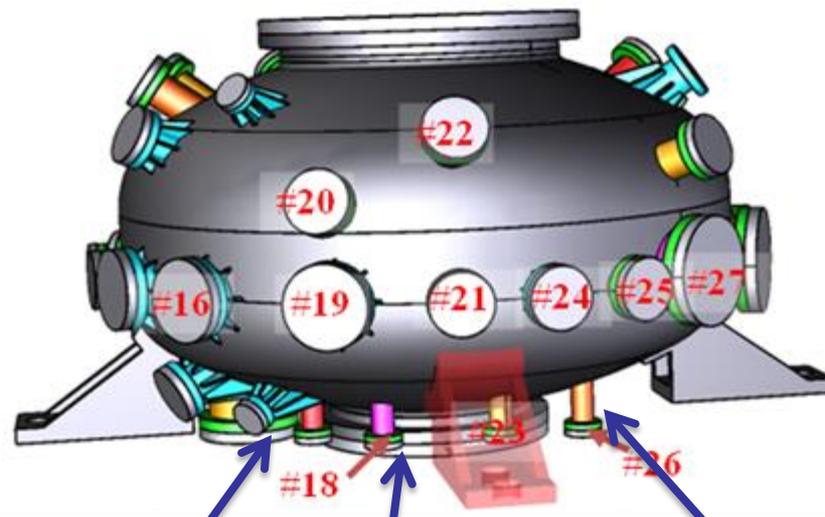
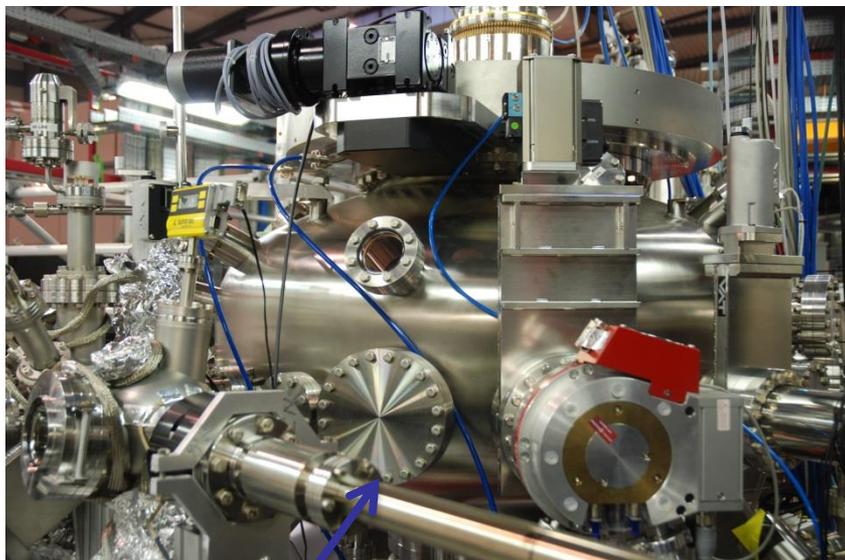
*PINK manufacturing (design based on reflectometer by C. Schüßler-Langeheine and co-workers at Helmholtz Zentrum Berlin& Köln Univ.)
Acknowledgements: PINK, F. Heigl(CFT), C.Ruget, S. Ferrer, C. Schüßler-Langeheine, E. Wesche, E. Pellegrin, ALBA metrology*

scattering endstation – overall concept



CAD design: A. Crisol, C. Coldelram and previous engineering staff (D. Barcescu, J. Moreno, R. Martin, S. Forcat, C. Ruget)

Multi-port chamber allows complementary surface science techniques and upgrades for further x-ray techniques



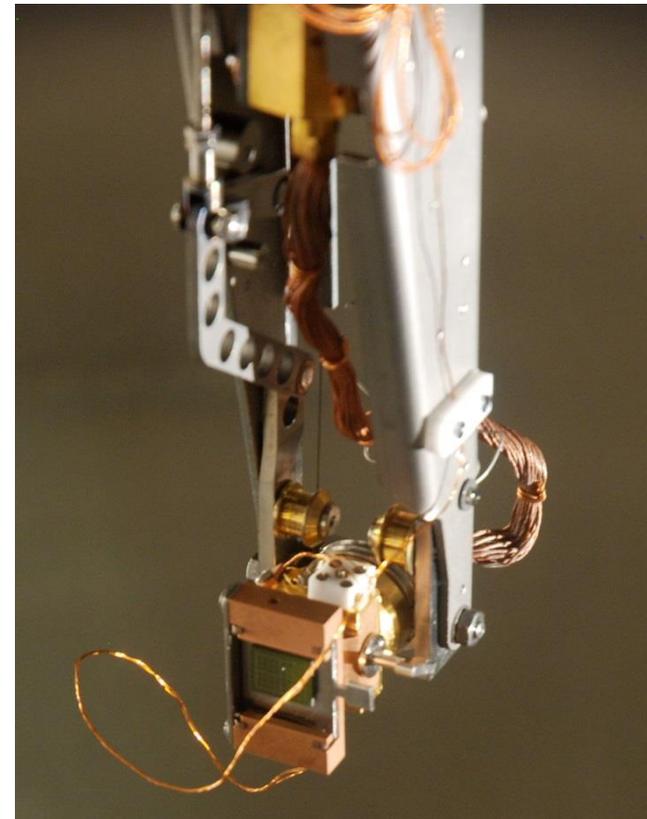
Large beam exit flange for SAXS tube, or fluo-screen + standard CCD

Oblique ports for evaporator in GISAXS incidence

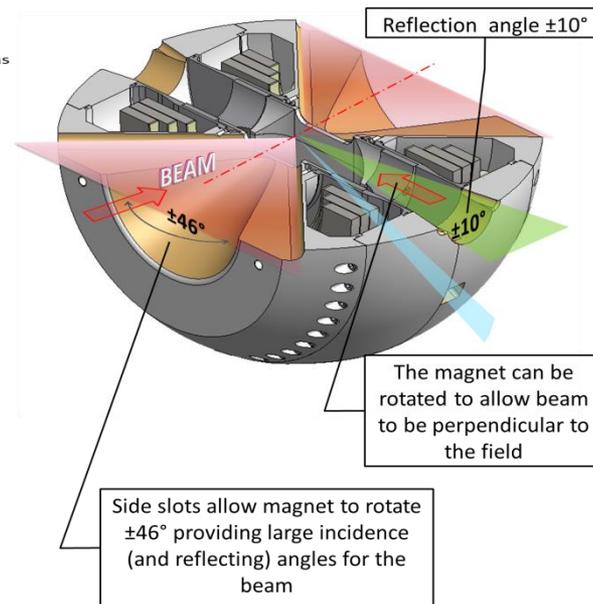
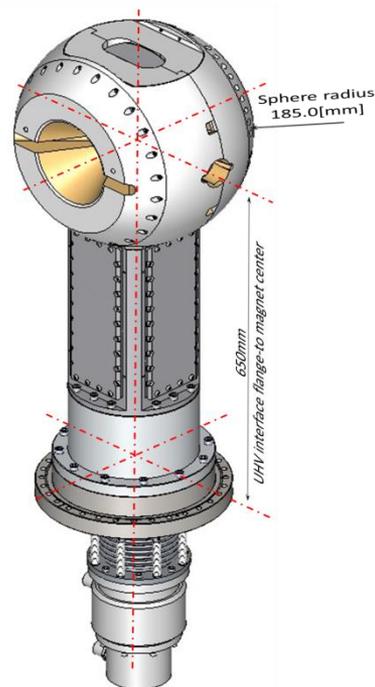
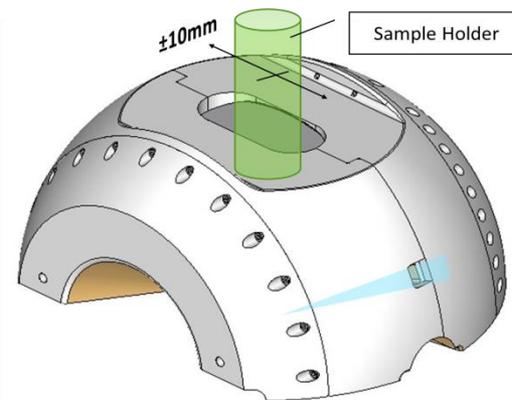
Entrance auxiliary port can have linear tool interpositioning element on incoming beam

Beam stopper port at diameter between Magnet and CCD

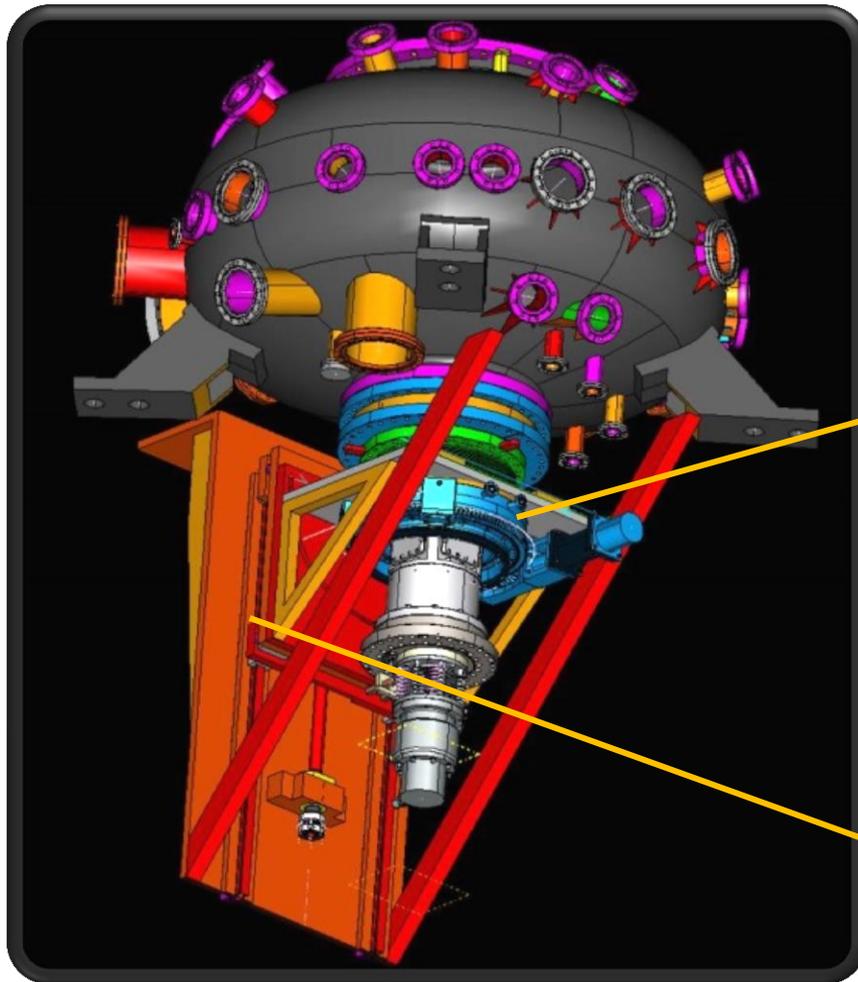
- IFW Dresden and VG Scienta design
custom modifications by VG Scienta & ALBA
- about 20K to 350 K sample temperature range
- XYZ, tilt, azimuth and polar (not used)
- in-vacuum sample transfer
- contacts for Hall probe or Temp sensor
- electron yield to be implemented
- STM plates sample holder, heating stage



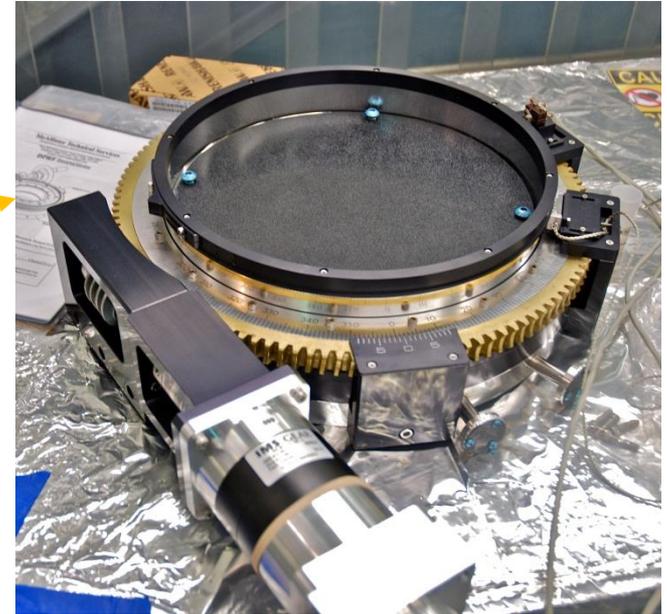
- Manufactured by HTS-110, design by HTS-110 and ALBA and ICMAB-CSIC
- 2 Tesla, 1st gen Bismuth strontium calcium copper oxide (BSSCO)
- Large-diameter coil packs for wide optical access, 50mm gap
- Cryocooler (28hours cooldown, Temp range 2nd stage 15-22 K approx.)
- Small stray field (<50G at 250mm), around 150 Kgs
- O-ring sealed, warm bore, dampening belows



magnet degrees of freedom, bottom stack



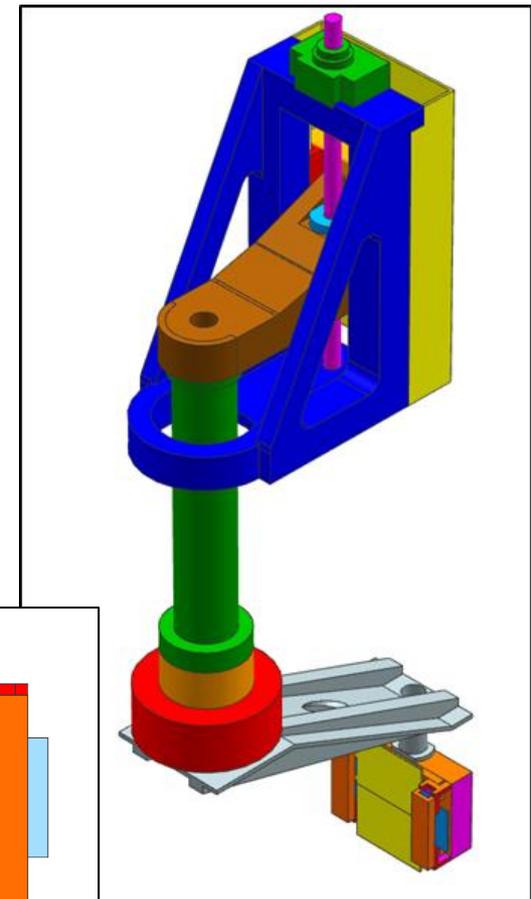
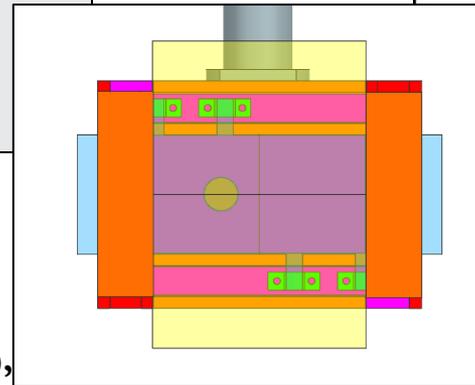
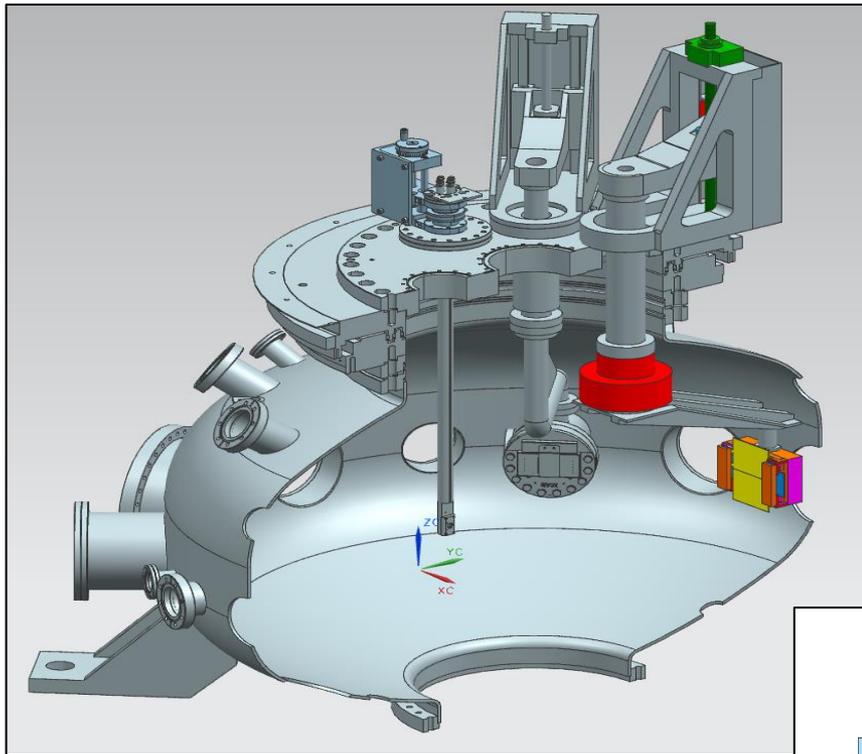
Magnet rotation (delivered July, from McAllister TS) . Under commissioning



Vertical motion and extraction tool, inhouse development (status: detailed final design, expected before fall 2014)

- *includes some tilt adjustment*
- *lowers magnet for transfer*
- *gets magnet fully down and would allow to take plate with magnet into a wheeled transportation cart*

Diode/MCP/Channeltron detector arm

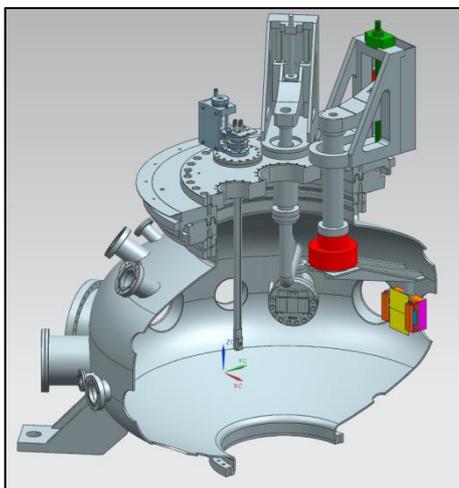


- Detectors: GaAsP diode & MCP (Hamamatsu),
Channeltron (Sjuts), Si diode (Hamamatsu/IRD)
- Vertical motion: range +/- 150 mm , resolution few micron
- Detector slits: smart act actuators

In-house design in progress (summer 2014):

A. Pascual, C. Ortiz,

A. Crisol, C. Colldelram, M. Valvidares



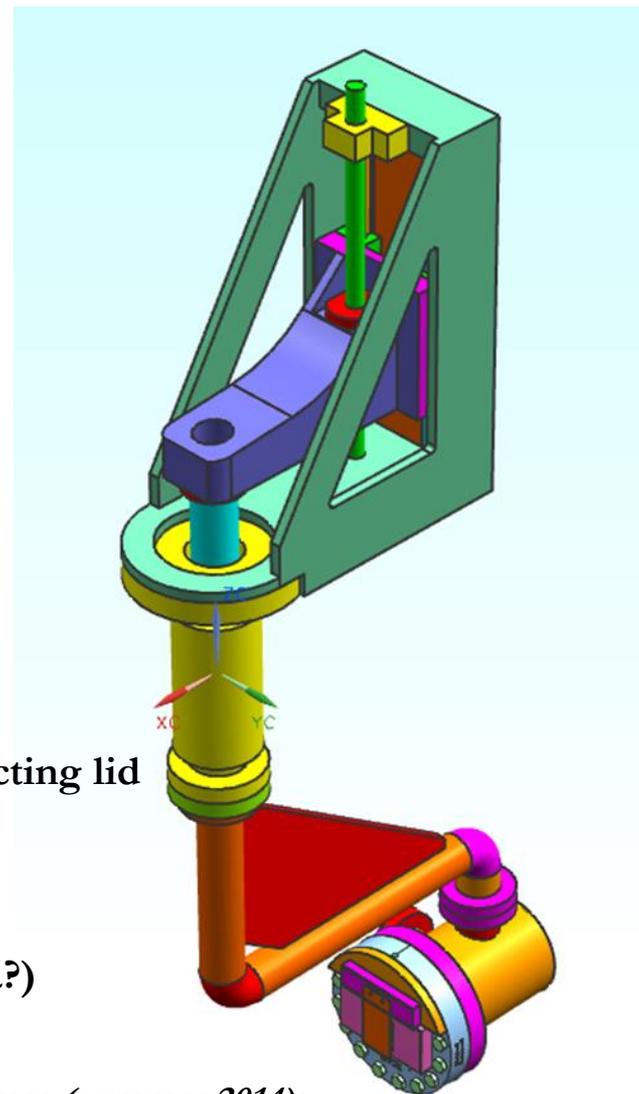
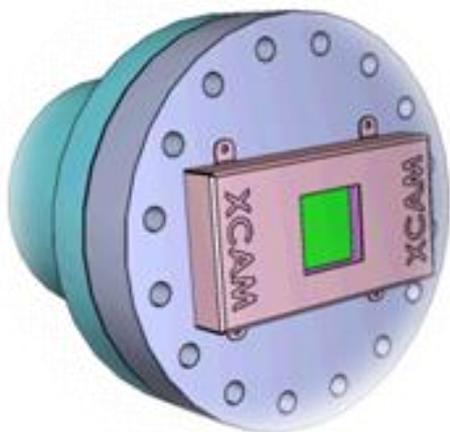
Custom design (CFT) by
XCAM Ltd, UK

CCD device and TEC element
in-side vacuum (-50C to -70C),
water cooled

custom camera head signal
feed-through with proximity
electronics outside vacuum

driving electronics at 2.5m

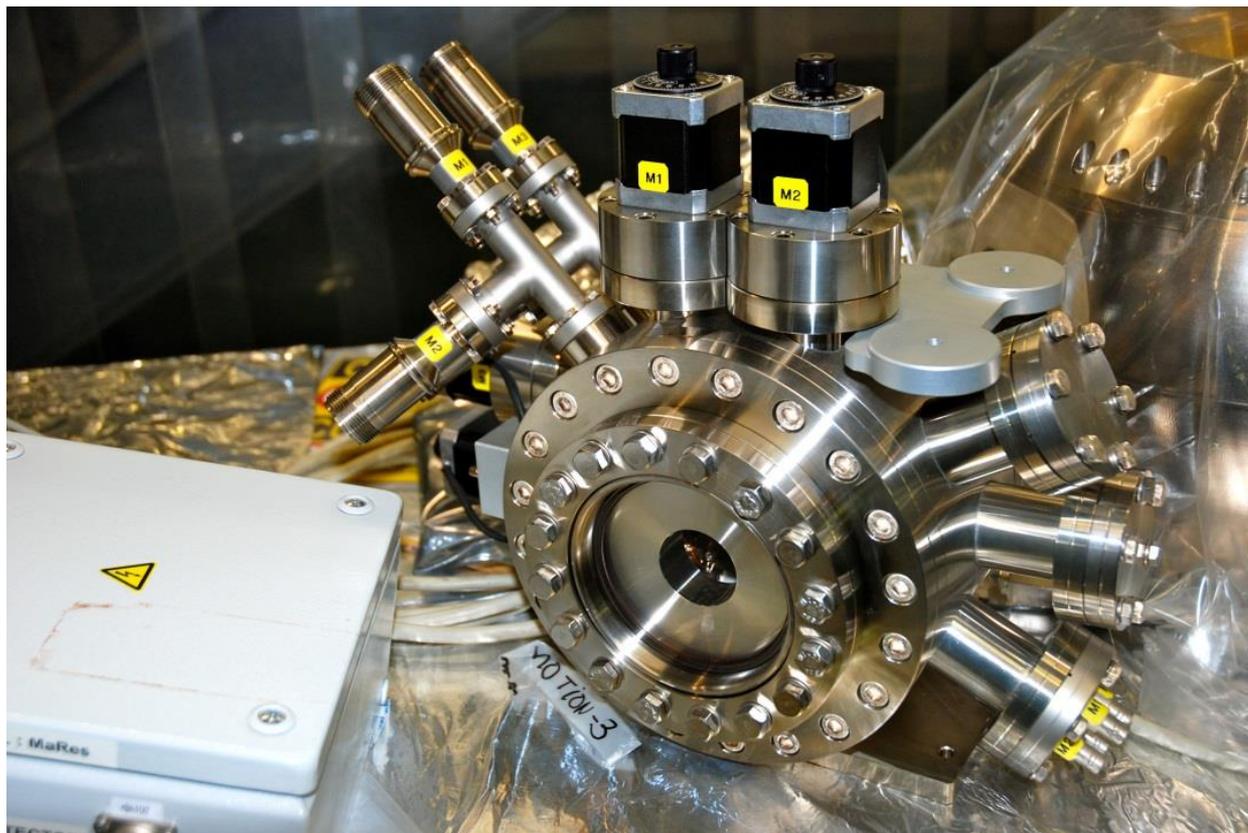
- in-house design arm
- Smart actuator for protecting lid
and fluo/RHEED screen
- beam stopper
- msec fast shutter (PiezoJena?)



In-house design in progress (summer 2014):

A. Pascual, C. Ortiz, A. Crisol, C. Colldelram, M. Valvidares

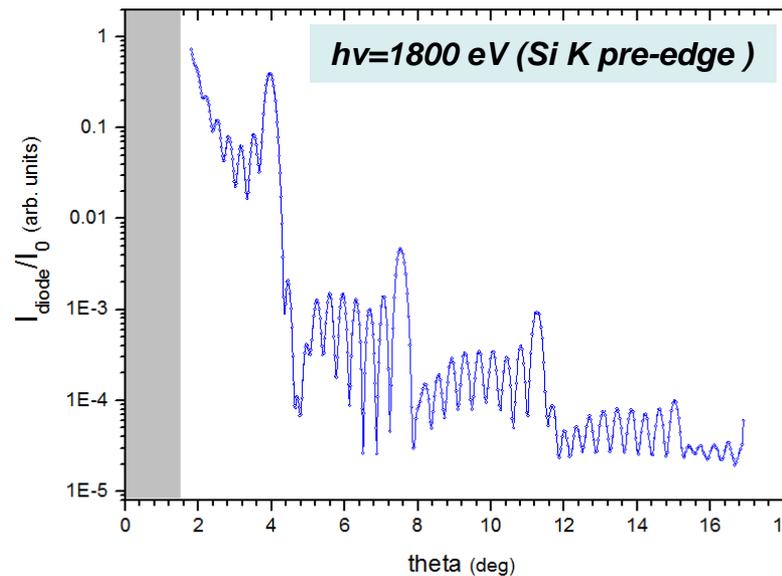
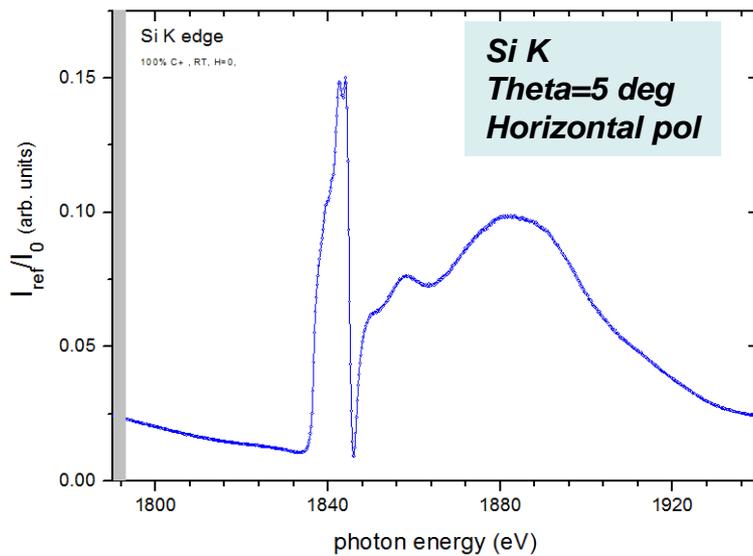
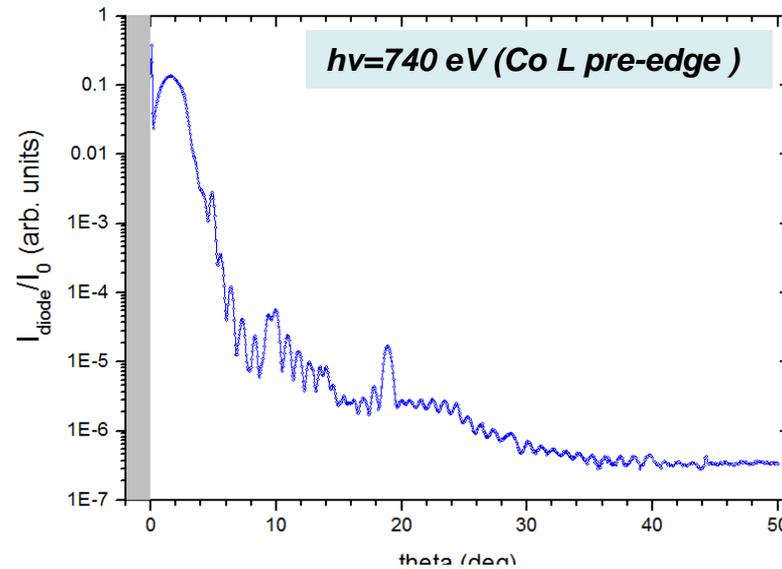
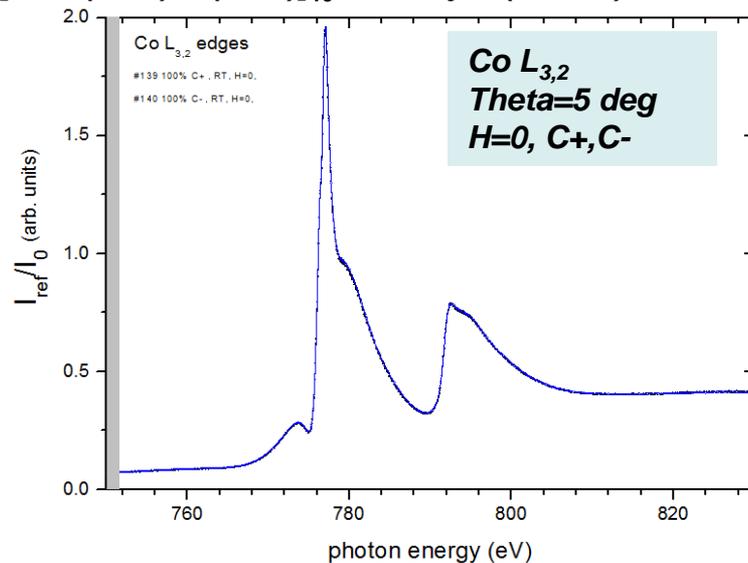
JJ-xray in-vacuum 4-blade slit system



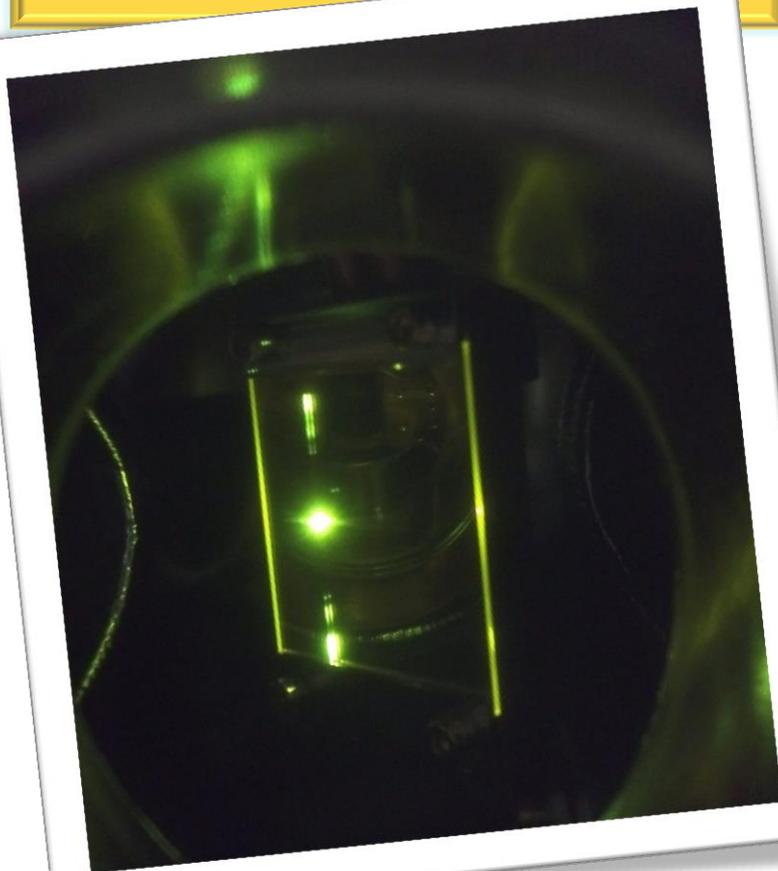
4-blade UHV slit system with manual/motorized micrometer actuators, blade drain current and in-vacuum encoders

first beam tests: reflectivity of a CoSi/Si ML

[CoSi(5nm)/Si(3nm)]₁₀ multilayer (CSZ22)



**THANKS FOR YOUR
ATTENTION AND INTEREST
ON BOREAS BEAMLINE !**



BL29 Staff

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J. Moldes (control), A. Crisol (eng.), F. Farre (tech.),
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